

Subject OB6611 Demo Board Manual	Board Model: OB6611_1902 Doc. No.: OB_DOC_DBM_A_661100
 A photograph of the OB6611 demo board. It is a circular green printed circuit board (PCB) with various electronic components mounted on it, including a central microcontroller, several surface-mount components, and a large electrolytic capacitor labeled "ON SEMICON". The PCB has a central circular cutout.	Key Feature: <ul style="list-style-type: none">• Sensorless motor control• Continuous average current: 12V/2.0A, 24V/1.0A• High speed motor support• Motor start fast, stuck restart• High precision and wide range speed control• OCP support• Fast phase to phase SCP• Small PCB size, simple BOM and assemble conveniently

Revision history:

Revise Date	Version	Reason/Issue
2019-01-21	00	First Issue

Contents Index

1.	System Electrical Specification	3
1.1	Input Characteristic	3
1.2	System parameters	3
1.3	Output characteristic	3
1.4	Environmental	3
2.	Board Information.....	4
2.1	Schematic.....	4
2.1.1	Bill of material	5
2.2	PCB Gerber File	5
2.3	Interface Function Description	6
2.4	BLDC Controller Board Snapshot	7
3.	Performance Evaluation.....	7
3.1	Voltage Test	8
3.1.1	Power ON/OFF & MCU Supply.....	8
3.1.2	MOSFET $V_{gs}/T_{r_h}/T_{r_l}/T_{f_h}/T_{f_l}$	8
3.1.3	V_{bat} Spike Voltage	9
3.2	PWM Test	10
3.2.1	PWM Frequency	10
3.2.2	Power On	11
3.2.3	Power Off	12
3.3	Current sampling	13
3.4	Motor Stuck Protect	14
3.5	Over Average Current Protect	15
3.6	Motor Short Circuit Protection	15
3.7	Mosfet Temperature Rise	16

Figures Index

Fig. 1	Measured MCU supply voltage and DC input voltage.....	8
Fig. 2	Measured MCU supply voltage and DC input voltage.....	8
Fig. 4-1(P MOS Modulation)	Measured phase U highside and lowside MOSFET $V_{gs}/T_{r_h}/T_{r_l}/T_{f_h}/T_{f_l}$..	8
Fig. 4-2(N MOS Modulation)	Measured phase U highside and lowside MOSFET $V_{gs}/T_{r_h}/T_{r_l}/T_{f_h}/T_{f_l}$..	9
Fig. 5-1(P MOS Modulation)	Measured V_{DC}/U phase voltage	9
Fig. 5-2(N MOS Modulation)	Measured V_{DC}/U phase voltage	10
Fig. 6-1(P MOS Modulation)	Measured phase U voltage	10
Fig. 6-2(N MOS Modulation)	Measured phase U voltage	11
Fig. 7-1(P MOS Modulation)	Measured V_{DC} voltage / phase U voltage and R_{cs} voltage	11
Fig. 7-2(N MOS Modulation)	Measured V_{bat} voltage / phase U voltage and R_{cs} voltage	12
Fig. 8-1(P MOS Modulation)	Measured V_{DC} voltage / phase U voltage and highside / lowside gate drive voltage.....	12
Fig. 8-2(N MOS Modulation)	Measured V_{DC} voltage / phase U voltage and highside / lowside gate drive voltage.....	13
Fig. 9-1(P MOS Modulation)	Measured phase U voltage and R_{cs} voltage.....	13
Fig. 9-2(N MOS Modulation)	Measured phase U voltage and R_{cs} voltage	14
Fig. 10	phase U voltage/motor stuck protect flag and R_{cs} voltage	14
Fig. 11	Measured V_{bat} / phase U voltage/OCP debounce toggle counter and R_{cs} voltage	15
Fig. 12	Measured Bus voltage, U-phase voltage and R_{cs} voltage @ input voltage = 10.0V	16

1. System Electrical Specification

1.1 Input Characteristic

- | | |
|--------------------|-----------|
| ▪ DC input voltage | 5V to 24V |
|--------------------|-----------|

1.2 System parameters

- | | |
|--|---------|
| ▪ PWM frequency | 20 KHz |
| ▪ MCU supply voltage | 5V |
| ▪ Current sampling resistance | 47mΩ±1% |
| ▪ Gate driver supply voltage(P MOS) | 6V(max) |
| ▪ Gate driver supply voltage(N MOS) | 5V |
| ▪ Max of MOSFET drain source voltage value | 30V |

1.3 Output characteristic

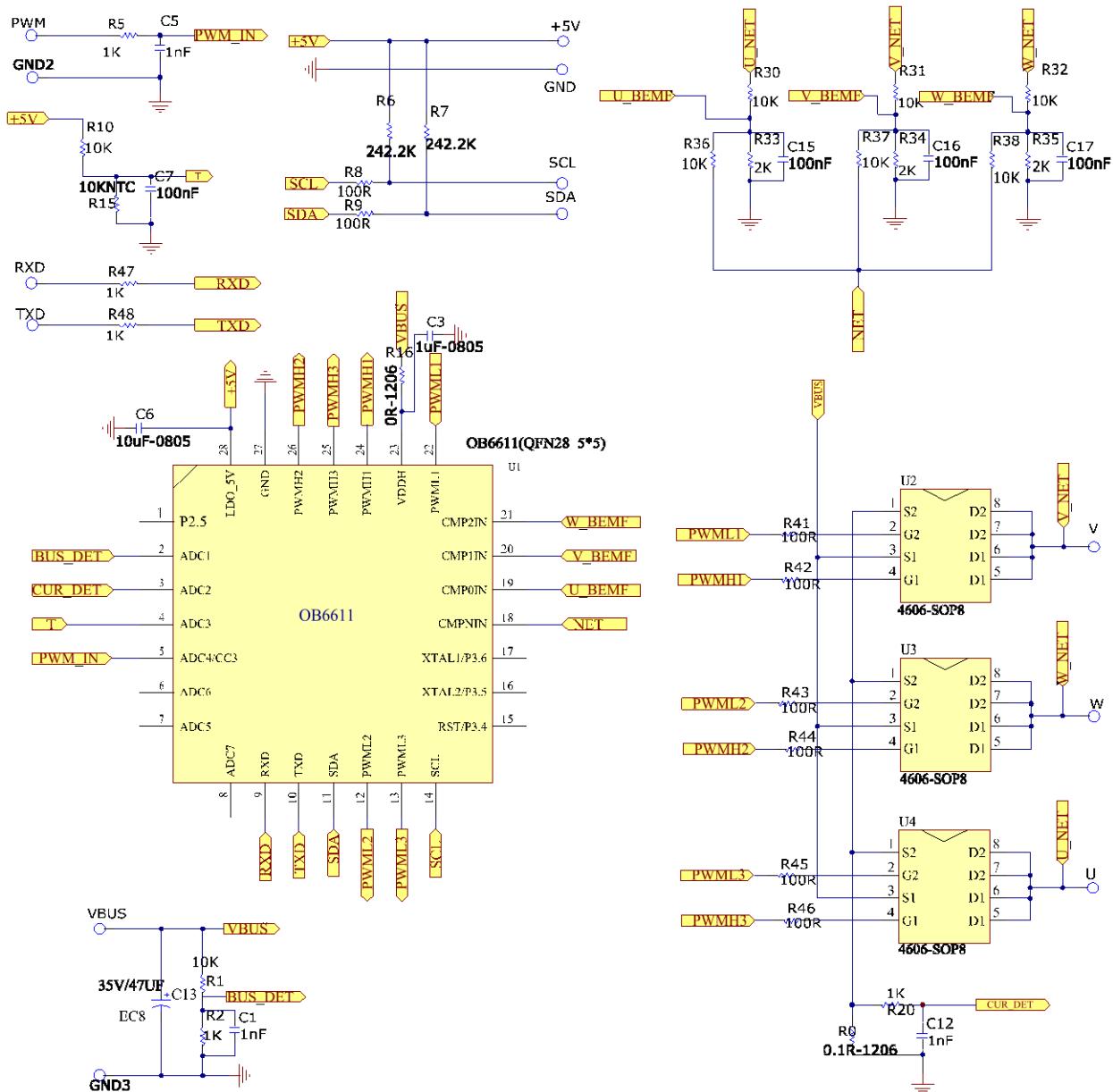
- | | |
|--|----------|
| ▪ Phase to phase shortcuit average current | 7A 0.5mS |
| ▪ Over average current | 5A 5S |
| ▪ Maximum of PWM duty | 100% |
| ▪ Minimum of PWM duty | 10% |

1.4 Environmental

- | | |
|---------------------------------|-----------------|
| ▪ Operating Ambient Temperature | -20 °C ~ 45 °C |
| ▪ Storage Temperature | -40 °C ~ 100 °C |
| ▪ Storage Humidity | 0 ~ 95% R.H. |

2. Board Information

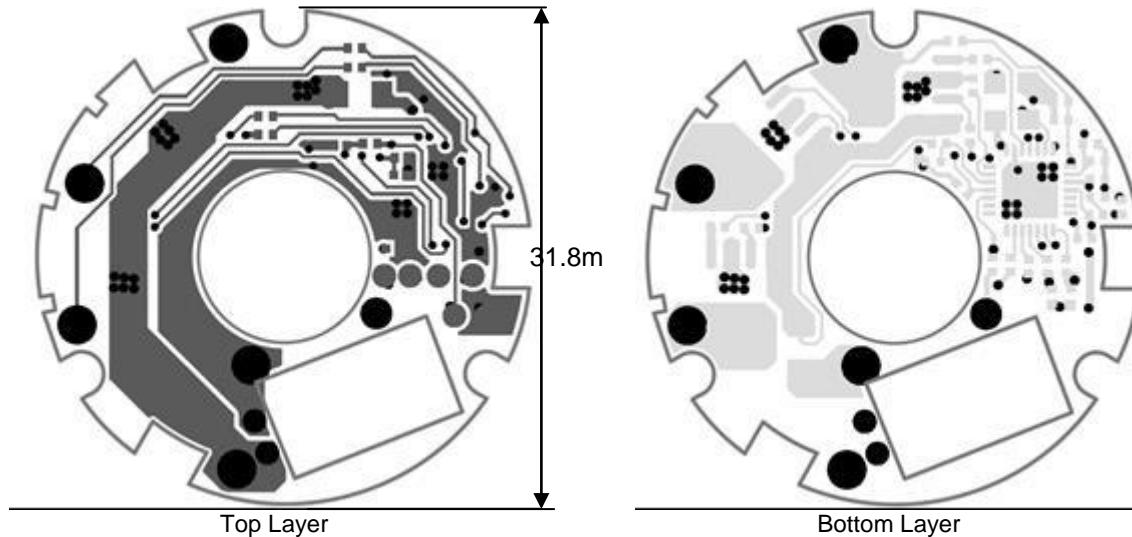
2.1 Schematic

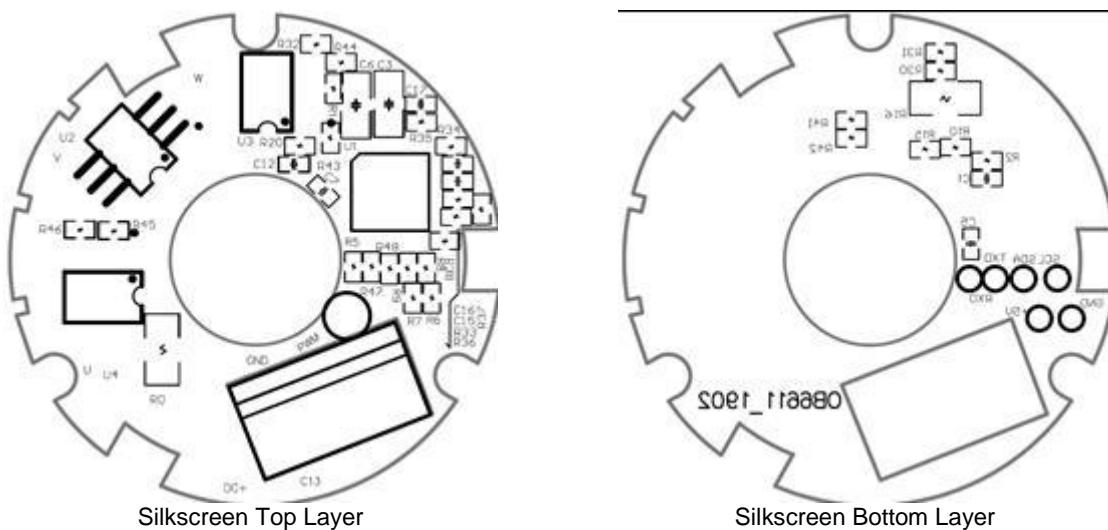


2.1.1 Bill of material

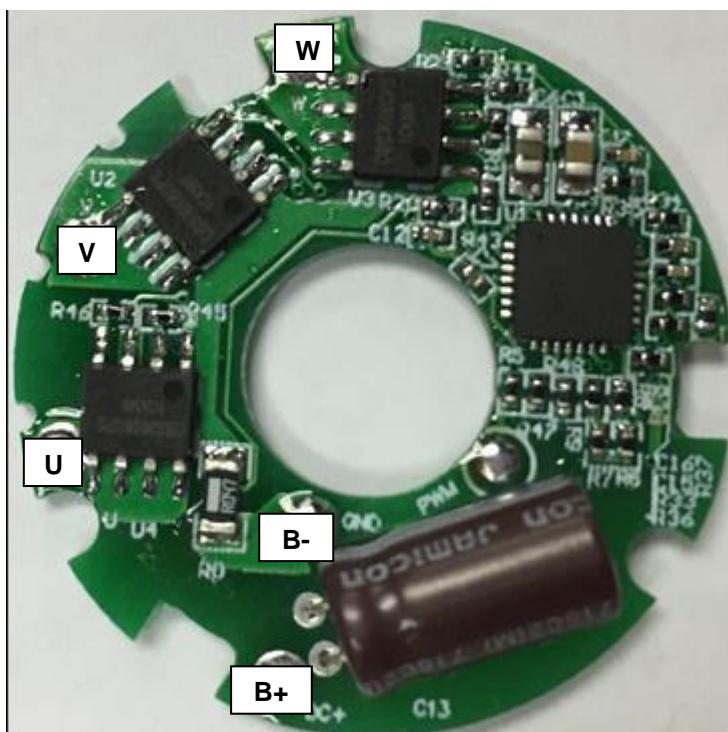
Designator	Package	Description	QTY
C13	EC8	Capacitor,electrolyte,47uf/50V	1
C6	C0805	Capacitor,ceramic,10uF/25V	1
C3	C0805	Capacitor,ceramic,1uF/25V	1
C7	C0805	Capacitor,ceramic,100nF/25V	1
C15,C16,C17	C0402	Capacitor,ceramic,100nF/25V	3
C1,C5,C12	C0402	Capacitor,ceramic,1nF/25V	3
R1, R10,R30,R31,R32,R36,R37,R38	R0402	Resistor,chip,10K,1%	8
R33, R34, R35	R0402	Resistor,chip,2K,1%	3
R2, R5,R20,R47,R48	R0402	Resistor,chip,1K,1%	5
R6,R7	R0402	Resistor,chip,242.2K,1%	2
R8,R9,R41,R42,R43,R44,R45,R46	R0402	Resistor,chip,100R,1%	8
R15	R0402	NTC,chip,10K,B=3950,1%	1
R0	R1206	Resistor,chip,47mR,1%	1
R16	R1206	Resistor,chip,0.0R,1%	1
PCB	31.8mm*31.8mm	1OZ , thickness 1.6mm	1
U2, U3, U4	SOP-8	OBS3006CPS	3
U1	QFN28	OB6611FIP	1

2.2 PCB Gerber File





2.3 Interface Function Description



HoleName	Description
B+	Battery input, Bus+
B-	Battery input, GND
U	Motor U phase output
V	Motor V phase output
W	Motor W phase output

2.4 BLDC Controller Board Snapshot



3. Performance Evaluation

This session presents the test results of OB6611 24.0V/1.0A electronic trimmer controller demo. Results on inrush current and safety test are not included and will be added when they become available. Overall, the module meets design specifications.

TA=20°C

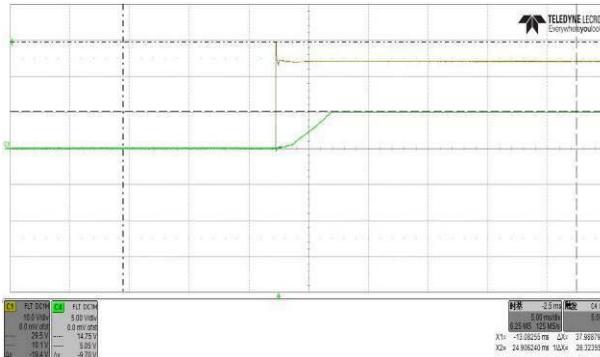
No	Parameter	Symbol	Min	Type	Max	Unit	Corresponding Fig.
1	MCU supply	V	4.9	5	5.1	V	Fig.1, Fig.2
3	MOSFET gate voltage	V_{gs}	4.0	5	6.0	V	Fig.4-1/ Fig.4-2
4	Highside MOSFET rise time(P/N)	T_{r_h}		200/400		ns	Fig.4-1/ Fig.4-2
5	Highside MOSFET fall time(P/N)	T_{f_h}		210/220		ns	Fig.4-1/ Fig.4-2
6	Lowside MOSFET rise time(P/N)	T_{r_l}		490/480		ns	Fig.4-1/ Fig.4-2
7	Lowside MOSFET fall time(P/N)	T_{f_l}		580/510		ns	Fig.4-1/ Fig.4-2
8	Bus supply voltage spike	V_{spike}		1.5		V	Fig.5-1/ Fig.5-2
9	PWM frequency	f_{PWM}		20		kHz	Fig.6-1/ Fig.6-2
10	Motor stuck protect time	T_{STP}		0.7		s	Fig.10
11	Over Current protect time	T_{STP}		5		s	Fig.11
12	Short Circuit Protection time	T_{STP}		0.5		ms	Fig.12

Test Equipments

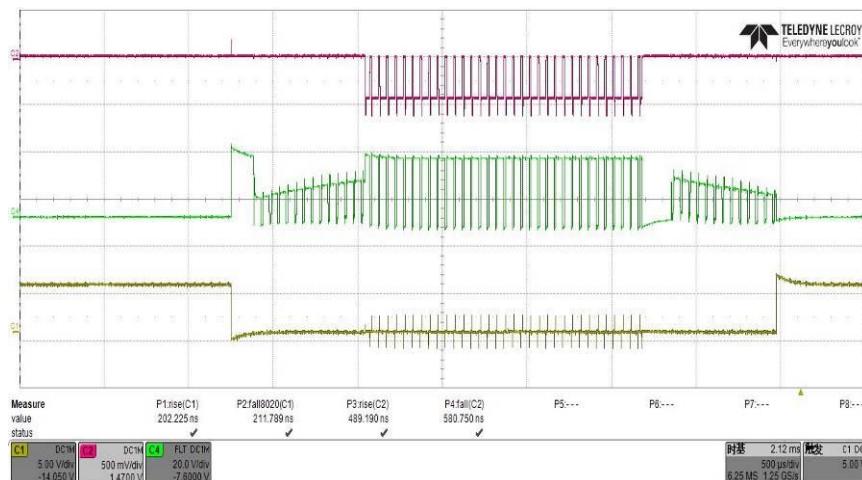
Item	Module
DC source	LW-12050KD
Oscilloscope	LeCroy 4024
Current meter	/
Differential probe	/
Thermo meter	DT-847U
Digital multimeter	FLUKE 15B+

3.1 Voltage Test

3.1.1 Power ON/OFF & MCU Supply



3.1.2 MOSFET V_{gs}/T_{r_h}/T_{r_l}/T_{f_h}/T_{f_l}



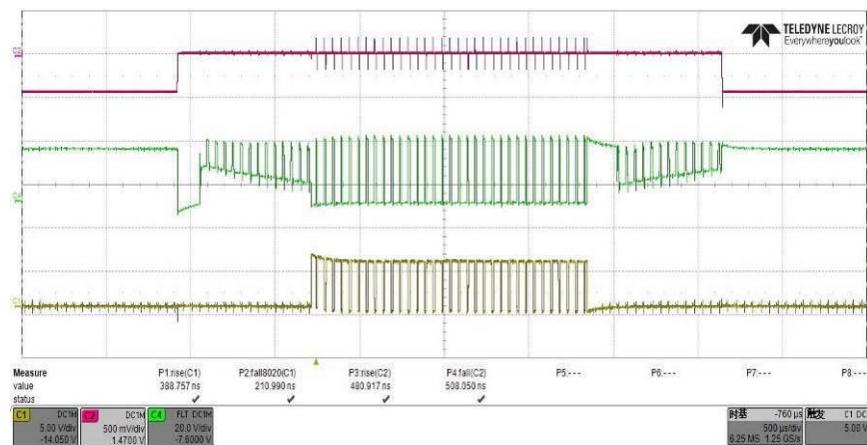


Fig. 4-2(N MOS Modulation)Measured phase U highside and lowside MOSFET $V_{gs}/T_{r_h}/T_r/T_{f_h}/T_f/T_{f_l}$

CH1:V_{GL} CH2:V_{GH} CH4:V_{MTR_PHS}

3.1.3 V_{bat} Spike Voltage

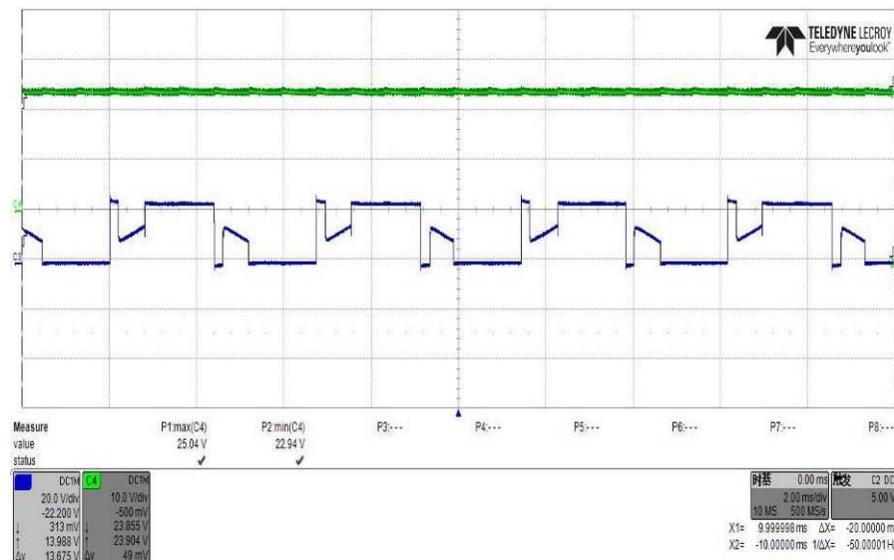


Fig. 5-1(P MOS Modulation)Measured V_{DC}/U phase voltage

CH1:V_{DC} CH3:V_{MTR_PHS}

100%占空比运行，母线电压波形

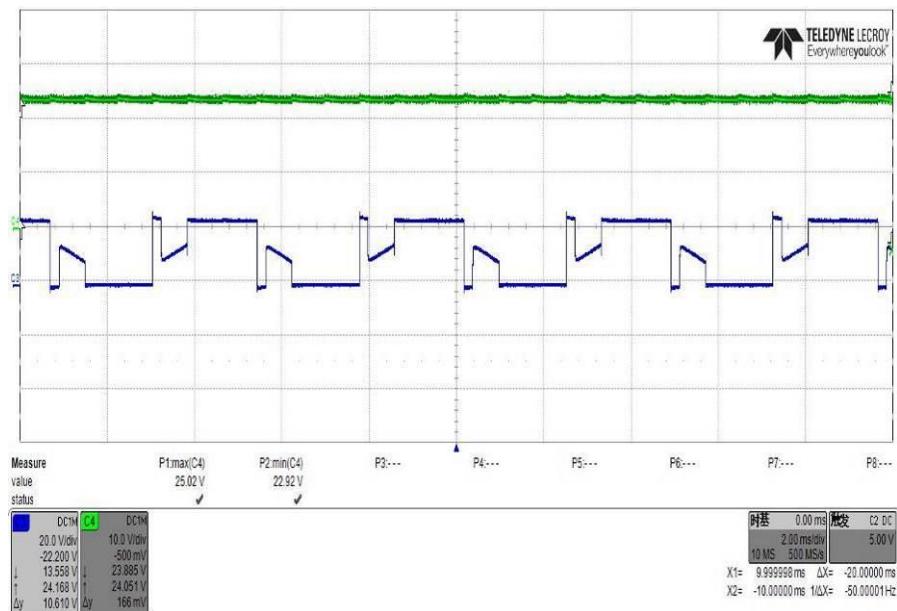


Fig. 6-2(N MOS Modulation)Measured V_{DC} / U phase voltage

CH1: V_{DC} CH3: V_{MTR_PHS}

100%占空比运行，母线电压波形

3.2 PWM Test

3.2.1 PWM Frequency

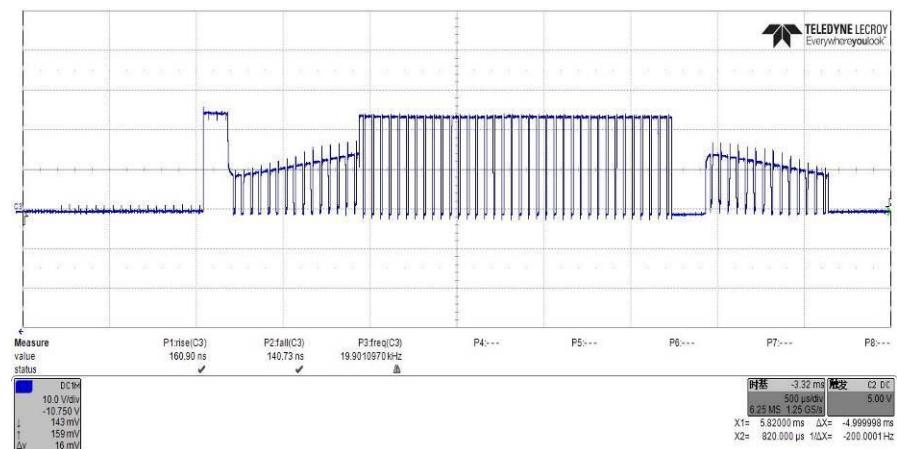


Fig. 7-1(P MOS Modulation)Measured phase U voltage

CH3: V_{MTR_PHS}

20.0KHz PWM 频率波形

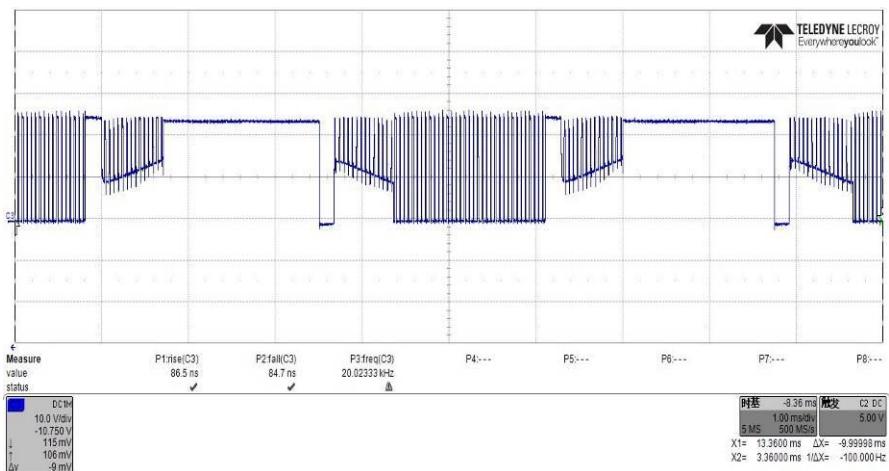


Fig. 8-2(N MOS Modulation)Measured phase U voltage

CH3: V_{MTR_PHS}

20.0KHz PWM 频率波形

3.2.2 Power On

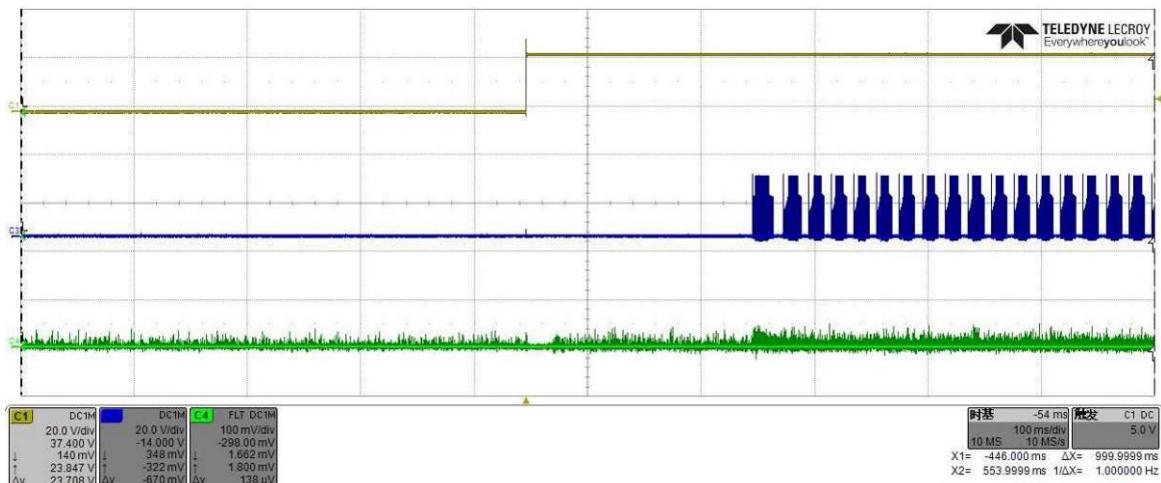
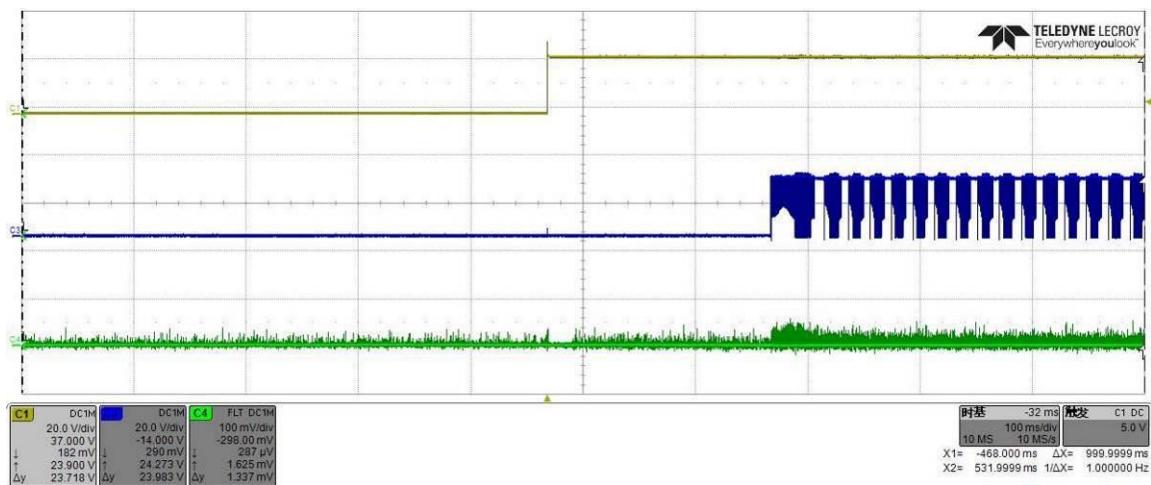


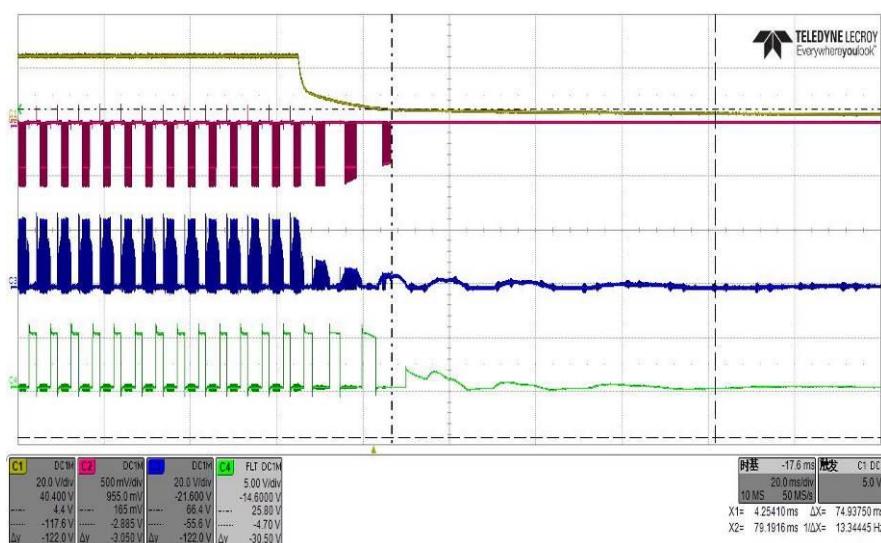
Fig. 9-1(P MOS Modulation)Measured V_{DC} voltage / phase U voltage and R_{CS} voltage

CH1: V_{DC} CH3: V_{MTR_PHS} CH4: I_{CS}

电机起动相电压和相电流波形



3.2.3 Power Off



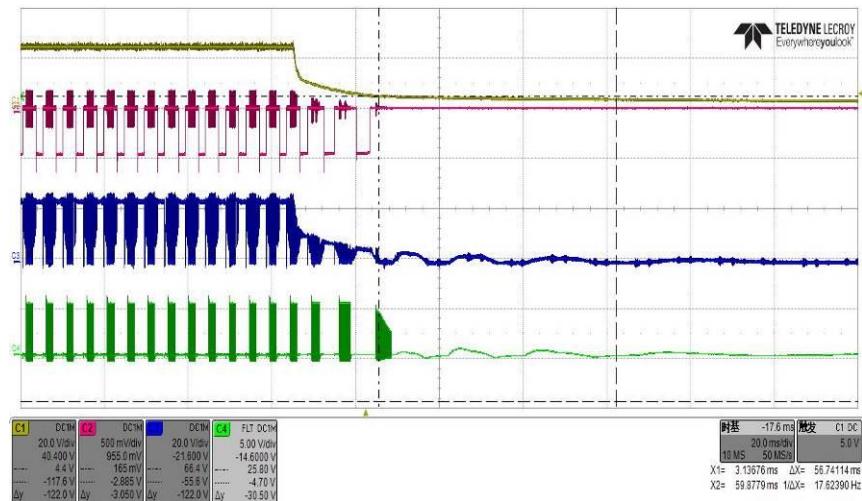


Fig. 12-2(N MOS Modulation)Measured V_{DC} voltage / phase U voltage and highside / lowside gate drive voltage

CH1:V_{DC} CH2:V_{GH} CH3:V_{MTR_PHS} CH4:V_{GL}

电池掉电过程电机相电压和上下管驱动波形

3.3 Current sampling

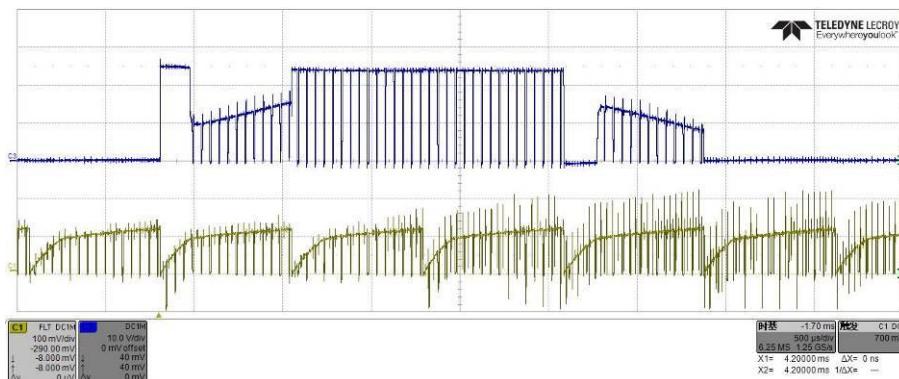


Fig. 13-1(P MOS Modulation)Measured phase U voltage and R_{cs} voltage

CH1: I_{CS} CH3: V_{MTR_PHS}

电机驱动时电机相电压和电流采样电阻两端电压波形

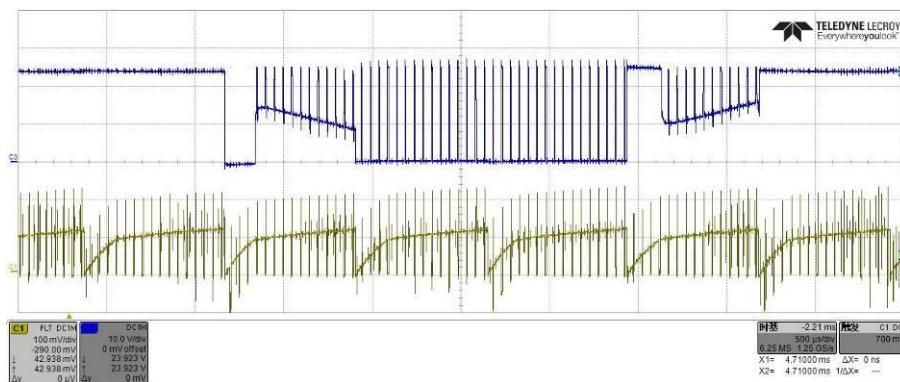


Fig. 14-2(N MOS Modulation)Measured phase U voltage and R_{cs} voltage

CH1: I_{CS} CH3: V_{MTR_PHS}

电机驱动时电机相电压和电流采样电阻两端电压波形

3.4 Motor Stuck Protect

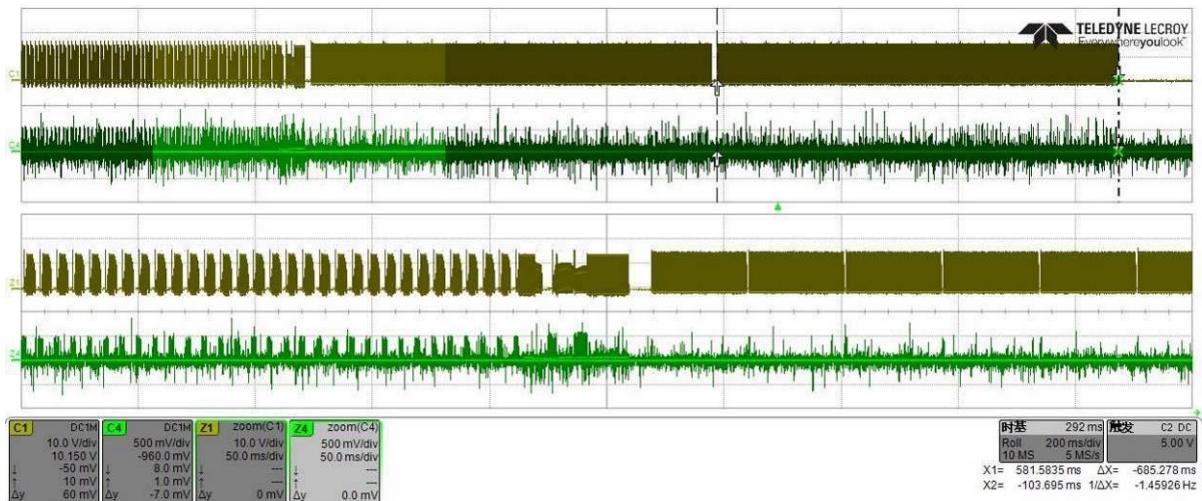


Fig. 15 phase U voltage/motor stuck protect flag and R_{cs} voltage

CH1: V_{MTR_PHS} CH4: I_{CS}

电机运行过程中堵住电机（堵转三次进入保护）

3.5 Over Average Current Protect

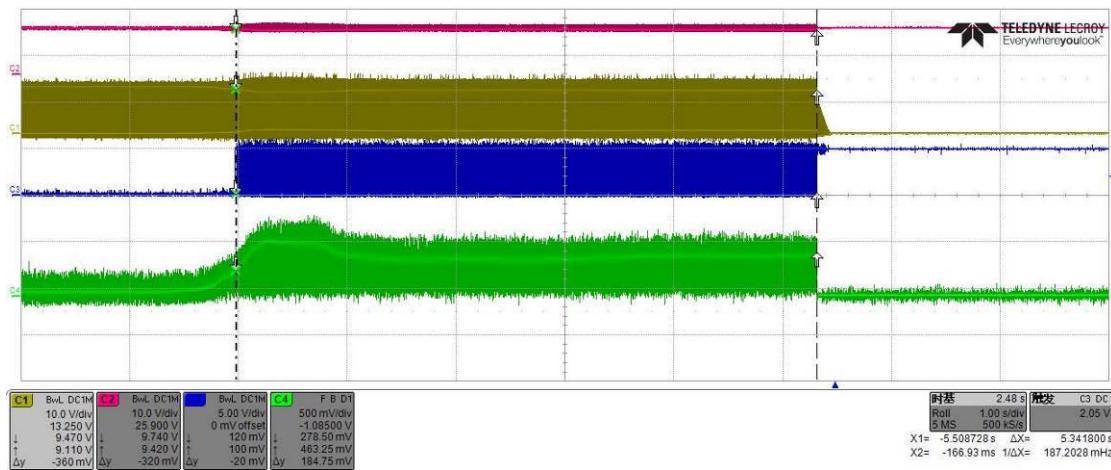


Fig. 16 Measured V_{bat} /phase U voltage/OCP debounce toggle counter and R_{cs} voltage

CH1: V_{MTR_PHS} CH2: V_{BAT} CH3:OCP debounce counter CH4: I_{CS}

过流保护 (5A) 波形

3.6 Motor Short Circuit Protection

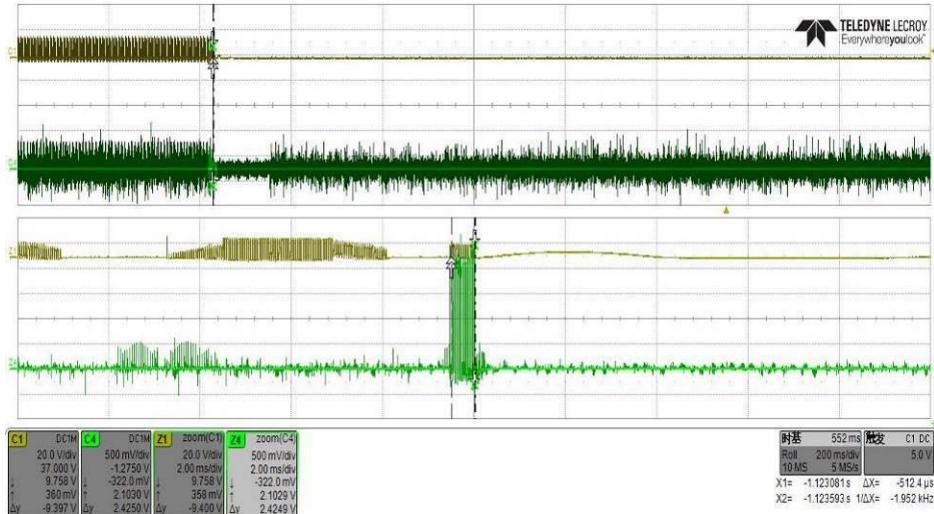


Fig. 12(P MOS Modulation)Measured phase U voltage and R_{cs} voltage @ input voltage = 12.0V

CH1: V_{MTR_PHS} CH4: I_{CS}

相间短路时电流采样电阻两端电压和短路保护波形

3.7 Mosfet Temperature Rise

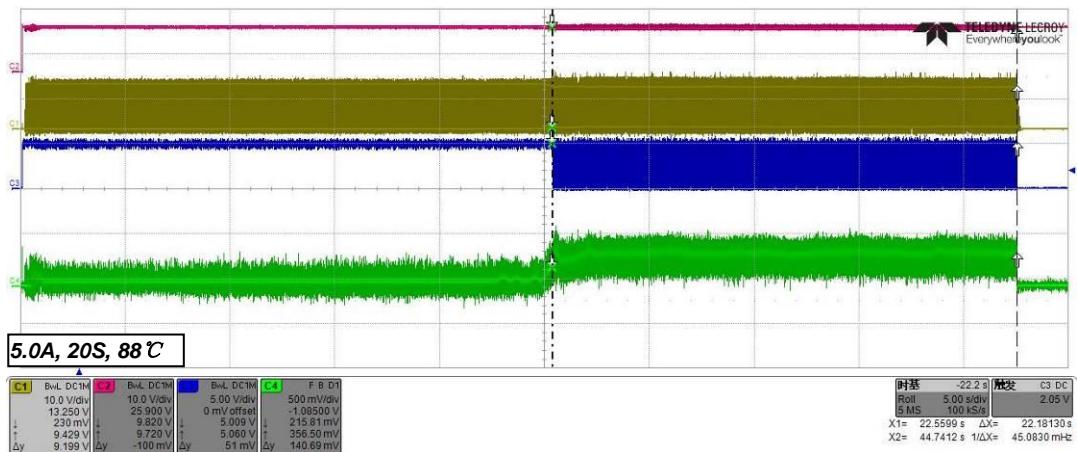


Fig. 17 Measured Bus voltage, U-phase voltage and R_{cs} voltage @ input voltage = 10.0V

CH1: V_{MTR_PHS} CH2: V_{BAT} CH3: OCP debounce counter CH4: I_{CS}

室温 20°C 下 5.0A 平均电流持续工作 20S, MOS 最高温度约为 88°C

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